Specification of Thermoelectric Module

TEHC1-16106

Description

The 161 couples, 40 mm × 40 mm size single module which is made of our high performance ingot to achieve superior cooling performance and 74°C or larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

Features

- High effective cooling and efficiency
- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly, RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

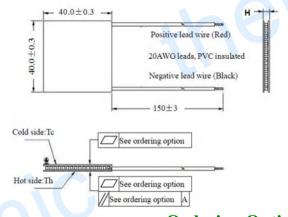
Application

- Food and beverage service refrigerator
- Portable cooler box for cars
- Temperature stabilizer
- Liquid cooling
- CPU cooler and scientific instrument
- Photonic and medical systems

Performance Specification Sheet

Th (°C)	27	50	Hot side temperature at environment: dry air, N ₂	
DT _{max} (°C)	74	83	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side	
U _{max} (Voltage)	21.2	22.8	Voltage applied to the module at DT _{max}	
I _{max} (Amps)	6.3	6.3	DC current through the modules at DT _{max}	
Q _{Cmax} (Watts)	85.3	93.1	Cooling capacity at cold side of the module under DT=0 °C	
AC resistance (Ohms)	2.55	2.7	The module resistance is tested under AC	
Tolerance (%)	± 10		For thermal and electricity parameters	

Geometric Characteristics Dimensions in millimeters



A. Solder:

1. T100: BiSn (Tmelt=138°C)

1. NS: No sealing (Standard)

2. T200: CuAgSn (Tmelt = 217° C)

2. SS: Silicone sealant

B. Sealant:

3. T240: SbSn (Tmelt = 240° C)

3. EPS: Epoxy sealant

C. Ceramics:

1. Alumina (Al₂O₃, white 96%)

D. Ceramics Surface Options:

1. Blank ceramics (not metalized)

2. Aluminum Nitride (AlN)

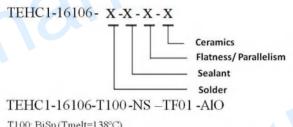
2. Metalized

Ordering Option

Suffix	Thickness	Flatness/	Lead wire length (mm)
	H / (mm)	Parallelism (mm)	Standard/Optional length
TF	0:3.75±0.1	0:0.08/0.08	150±3/Specify
TF	1:3.75±0.03	1:0.03/0.03	150±3/Specify

Eg. TF01: Thickness 3.75±0.1(mm) and Flatness 0.03/0.03(mm)

Naming for the Module

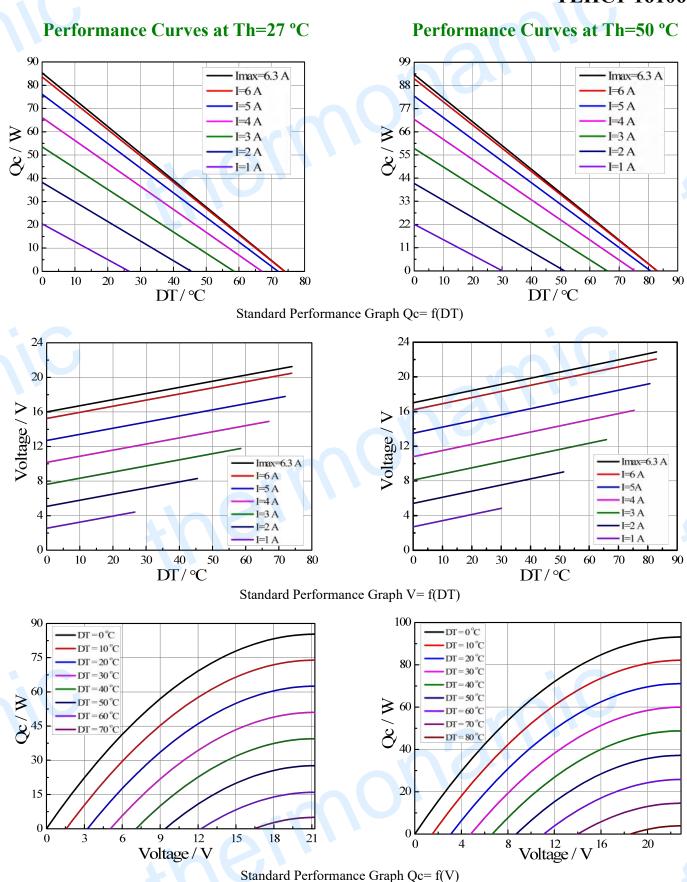


T100: BiSn(Tmelt=138°C)

NS: No sealing AlO: Alumina (Al2O3, white 96%)

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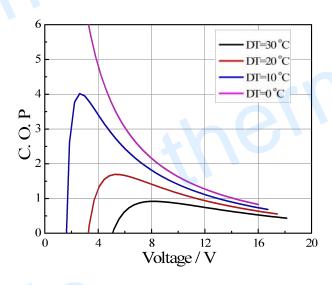


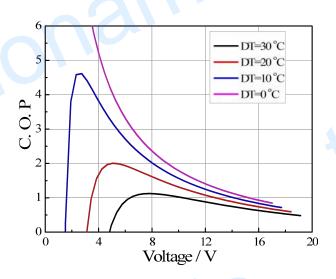
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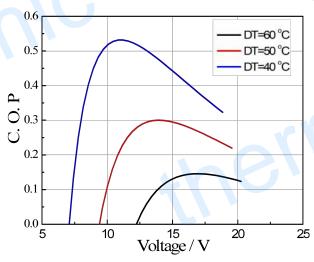
Performance Curves at Th=27 °C

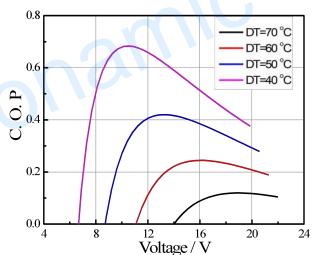
Performance Curves at Th=50 °C





Standard Performance Graph COP = f(V) of DT ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

Remark: The coefficient of performance (COP) is the cooling power Qc/Input power (V \times I).

Operation Cautions

- Attach the cold side of module to the object to be cooled
- Attach the hot side of module to a heat radiator for heat dissipating
- Operation below I_{max} or V_{max}
- Work under DC